

碳化硅肖特基二极管

Silicon Carbide Schottky Diode

KS10065-AI

V_{RRM}	=	650 V
$I_F (T_C=154^{\circ}C)$	=	10 A
Q_C	=	33 nC

特点 / Features

- 肖特基整流器 / 650-Volt Schottky Rectifier
- 零反向恢复电流 / Zero Reverse Recovery Current
- 零正向恢复电压 / Zero Forward Recovery Voltage
- 高工作频率 / High-Frequency Operation
- 不受温度影响的开关特性 / Temperature-Independent Switching Behavior
- 高速开关 / Extremely Fast Switching
- V_F 正温度特性 / Positive Temperature Coefficient on V_F

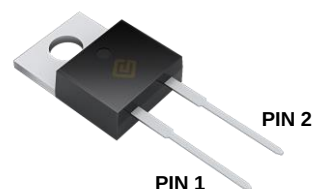
优势 / Benefits

- 电隔离封装 / Electrically Isolated Package
- 单极器件 / Replace Bipolar with Unipolar Rectifiers
- 零开关损耗 / Essentially No Switching Losses
- 高效率 / Higher Efficiency
- 减小散热器 / Reduction of Heat Sink Requirements
- 易于并联使用 / Ease of Paralleling

应用领域 / Applications

- 高压交流电 / HVAC
- 开关电源 / Switch Mode Power Supplies (SMPS)
- 功率因数校正 / Power Factor Correction
- 电机驱动 / Motor Drives
- 交流/直流转换器 / AC/DC converters

封装 / Package



ITO-220-2L



Part Number	Package	Marking
KS10065-AI	ITO-220-2L	KS10065AI

最大额定值 / Maximum Rated Values ($T_C=25^{\circ}\text{C}$ unless otherwise specified)

符号 Symbol	参数 Parameter	值 Value	单位 Unit	测试条件 Test Conditions	备注 Note
V_{RRM}	反向重复峰值电压 Repetitive peak reverse voltage	650	V		
V_R	直流反向阻断电压 DC Peak Reverse Voltage	650	V		
I_F	正向电流 Continuous Forward Current	37 16 10	A	$T_C=25^{\circ}\text{C}$ $T_C=135^{\circ}\text{C}$ $T_C=154^{\circ}\text{C}$	Figure 3
I_{FRM}	正向重复峰值电流 Repetitive Peak Forward Surge Current	80 63	A	$T_C=25^{\circ}\text{C}$, $t_P=10\text{ms}$, Half Sine Pulse $T_C=110^{\circ}\text{C}$, $t_P=10\text{ms}$, Half Sine Pulse	
I_{FSM}	正向浪涌电流 Non-Repetitive Forward Surge Current	105 93	A	$T_C=25^{\circ}\text{C}$, $t_P=10\text{ms}$, Half Sine Pulse $T_C=110^{\circ}\text{C}$, $t_P=10\text{ms}$, Half Sine Pulse	Figure 9
$I_{F,MAX}$	非重复正向峰值电流 Non-Repetitive Peak Forward Current	783 652	A	$T_C=25^{\circ}\text{C}$, $t_P=10\mu\text{s}$, Square Wave Pulse $T_C=110^{\circ}\text{C}$, $t_P=10\mu\text{s}$, Square Wave Pulse	Figure 9
P_{tot}	耗散功率 Power Dissipation	111 48	W	$T_C=25^{\circ}\text{C}$ $T_C=110^{\circ}\text{C}$	Figure 4
T_J	工作结温 Operating Temperature	-55 to +175	$^{\circ}\text{C}$		
T_{stg}	储存温度 Storage Temperature	-55 to +175	$^{\circ}\text{C}$		

电气参数 / Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise specified)

符号 Symbol	参数 Parameter	值 / Value			单位 Unit	测试条件 Test Conditions	备注 Note
		Min.	Typ.	Max.			
V_{DC}	击穿电压 DC blocking voltage	650			V	$I_R=200\mu\text{A}$	
V_F	正向电压 Forward Voltage		1.33 1.5	1.7 2.0	V	$I_F=10\text{A}$, $T_J=25^{\circ}\text{C}$ $I_F=10\text{A}$, $T_J=175^{\circ}\text{C}$	Figure 1
I_R	反向电流 Reverse Current		1 80	20 160	μA	$V_R=650\text{V}$, $T_J=25^{\circ}\text{C}$ $V_R=650\text{V}$, $T_J=175^{\circ}\text{C}$	Figure 2
Q_C	容性电荷 Total Capacitive Charge		33		nC	$V_R=400\text{V}$, $T_J=25^{\circ}\text{C}$	Figure 5
C	总电容 Total Capacitance		655 61 54		pF	$V_R=0\text{V}$, $T_J=25^{\circ}\text{C}$, $f=1\text{MHz}$ $V_R=200\text{V}$, $T_J=25^{\circ}\text{C}$, $f=1\text{MHz}$ $V_R=400\text{V}$, $T_J=25^{\circ}\text{C}$, $f=1\text{MHz}$	Figure 6
E_C	电容存储能量 Capacitance Stored Energy		4.8		μJ	$V_R=400\text{V}$	Figure 7

符号 Symbol	参数 Parameter	值 Value	单位 Unit	备注 Note
$R_{\theta JC}$	结壳热阻 Thermal Resistance(Junction to Case)	1.35	$^{\circ}\text{C/W}$	Figure 8

特性曲线 / Typical Performance

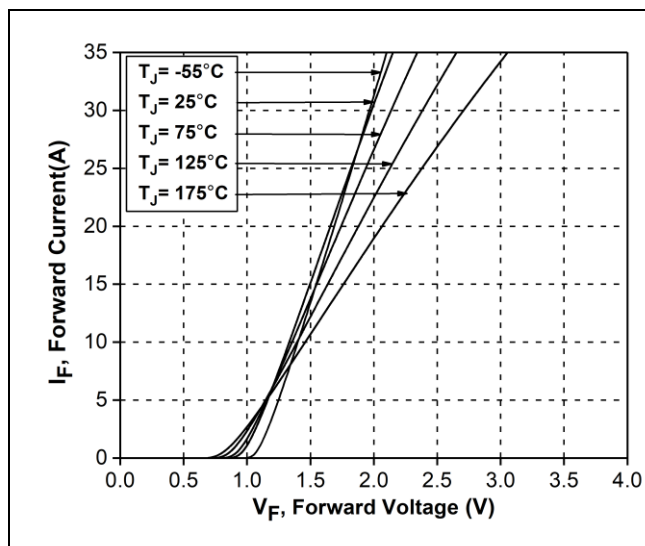


Figure 1. Forward Characteristics

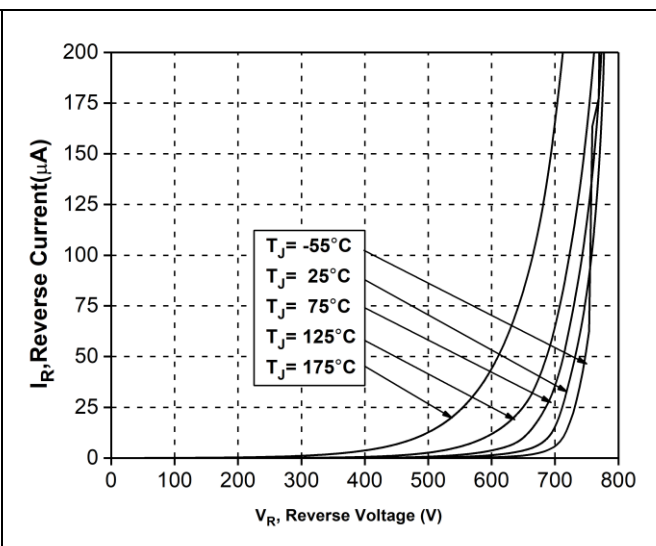


Figure 2. Reverse Characteristics

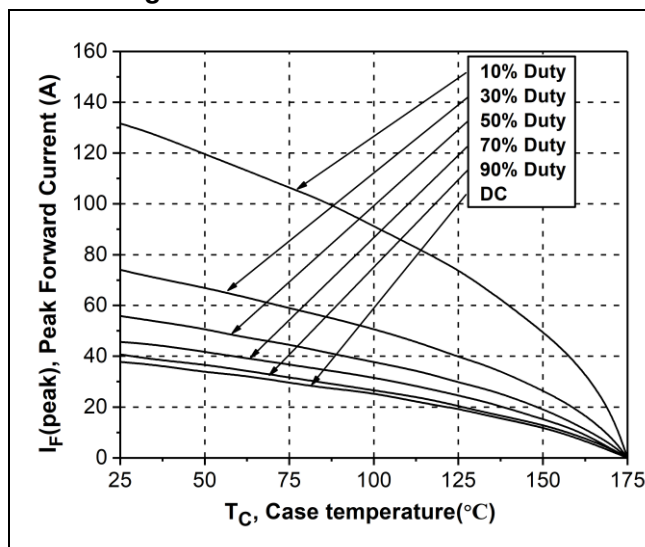


Figure 3. Current Derating

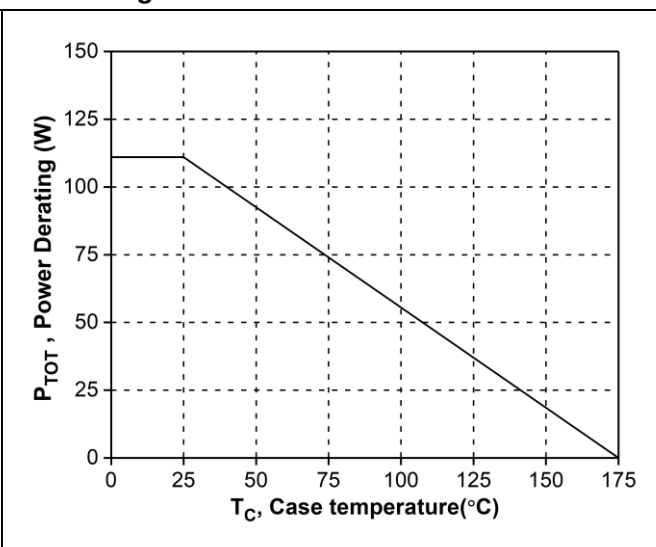


Figure 4. Power Derating

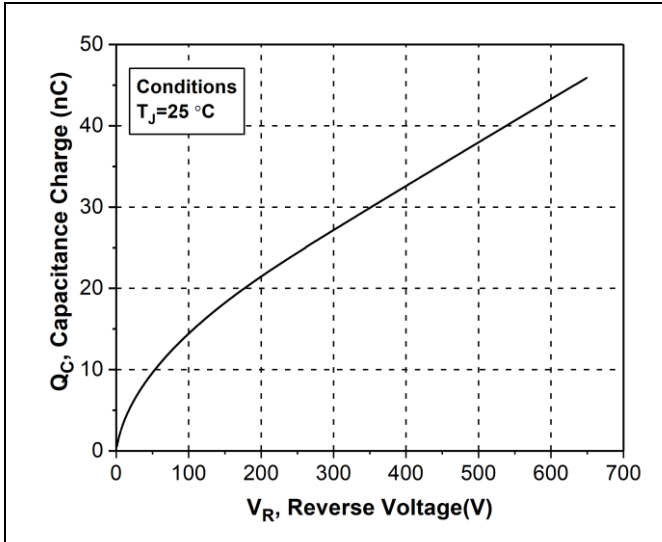


Figure 5. Capacitance Charge Vs. Reverse Voltage

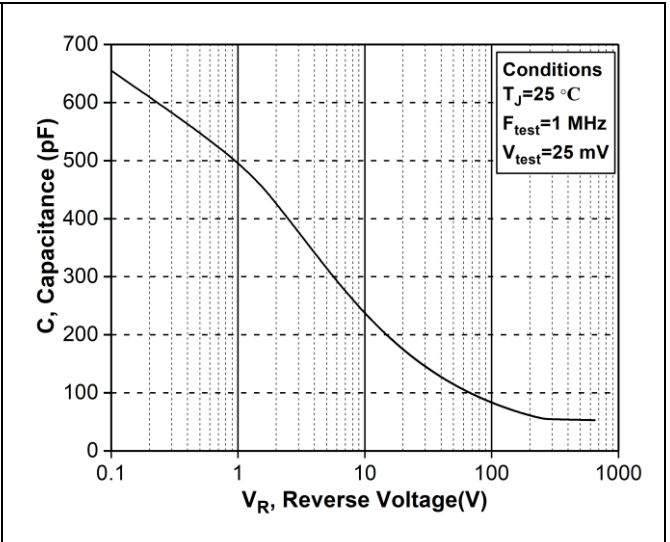


Figure 6. Capacitance Vs. Reverse Voltage

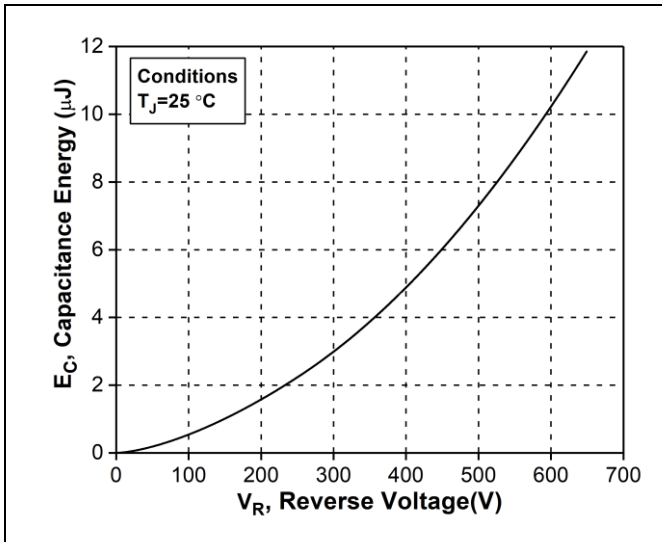


Figure 7. Capacitance Stored Energy

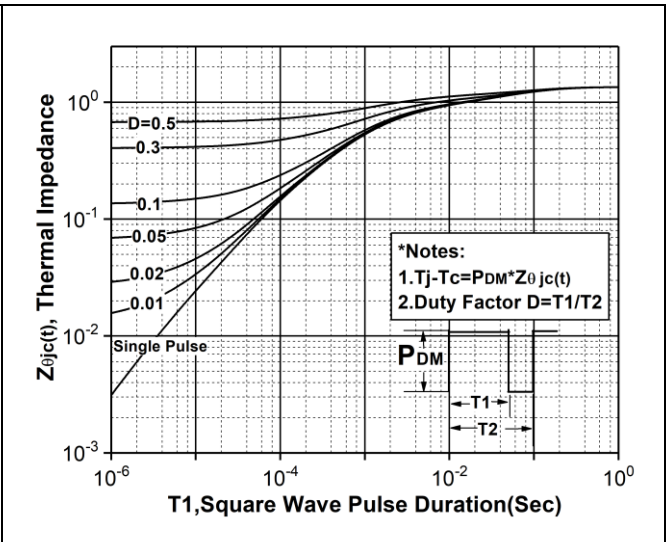


Figure 8. Transient Thermal Response Curve(Junction-to-Case)

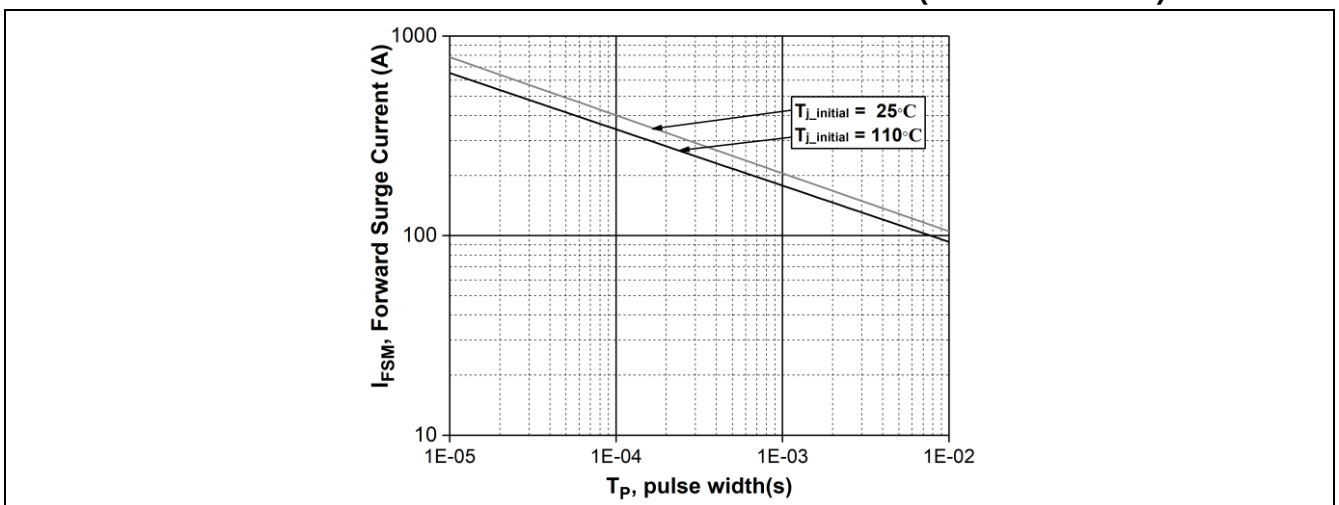
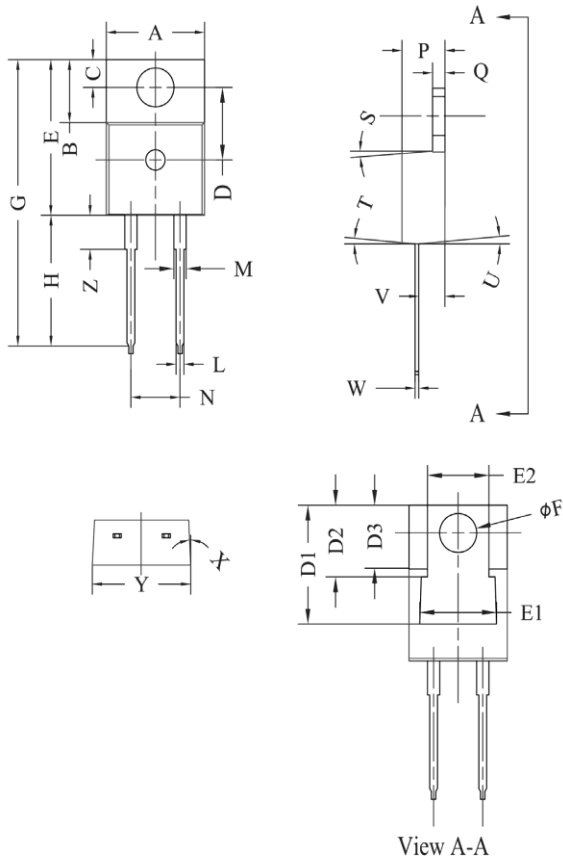
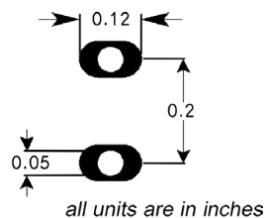


Figure 9. Non-repetitive peak forward surge current versus pulse duration (sinusoidal waveform)

Package ITO-220-2L


POS	Inches		Millimeters	
	Min	Max	Min	Max
A	.381	.410	9.677	10.414
B	.235	.255	5.969	6.477
C	.100	.120	2.540	3.048
D	.223	.337	5.664	8.560
D1	.457-.490		11.60-12.45 typ	
D2	.277-.303 typ		7.04-7.70 typ	
D3	.244-.252 typ		6.22-6.4 typ	
E	.590	.615	14.986	15.621
E1	.302	.326	7.68	8.28
E2	.227	.251	5.77	6.37
F	.143	.153	3.632	3.886
G	1.105	1.147	28.067	29.134
H	.500	.550	12.700	13.970
L	.025	.036	.635	.914
M	.045	.055	1.143	1.550
N	.195	.205	4.953	5.207
P	.165	.185	4.191	4.699
Q	.048	.054	1.219	1.372
S	3°	6°	3°	6°
T	3°	6°	3°	6°
U	3°	6°	3°	6°
V	.094	.110	2.388	2.794
W	.014	.025	.356	.635
X	3°	5.5°	3°	5.5°
Y	.385	.410	9.779	10.414
z	.130	.150	3.302	3.810

NOTE: Dimension L, M, W apply for Solder Dip Finish

参考焊盘图 / Recommended Solder Pad Layout


ITO-220-2L

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